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PATENT

Attorney Docket No.: 007685/PMG/EPIC/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:) Group Art Unit: 2818
Judon Tony PAN) Examiner: unknown at this time)
Serial No.: 10/654,240 Confirmation No.: 4883 Filed: 09/02/2003) TRANSMITTAL LETTER)
) PATENT COUNSEL
For: Bond Pad Techniques For Integrated Circuits	 APPLIED MATERIALS, INC. Legal Affairs Department P.O. Box 450 A Santa Clara, CA 95052
MS Patent Application	
Commissioner for Patents	
P.O. Box 1450	
Alexandria, VA 22313-1450	
Sir:	

TRANSMITTAL OF FORMAL DRAWINGS

Enclosed please find thirteen (13) sheets of formal drawings for the aboveidentified application. Each sheet of drawings provides identifying indicia on the front.

Respectfully submitted,

Dated: El. 25, 2004

Albert I Dalbuise

Reg. No.: 36,117

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope to: MS Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

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